# SiHP17N60D

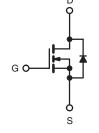




# **D** Series Power MOSFET

PRODUCT SUMMARY				
$V_{DS}$ (V) at $T_{J}$ max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.340			
Q <sub>g</sub> (Max.) (nC)	90			
Q <sub>gs</sub> (nC)	14			
Q <sub>gd</sub> (nC)	22			
Configuration	Single			





N-Channel MOSFET

## **FEATURES**

- Optimal Design
  - Low Area Specific On-Resistance
  - Low Input Capacitance (Ciss)
  - Reduced Capacitive Switching Losses
  - High Body Diode Ruggedness
  - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
  - Low Cost
  - Simple Gate Drive Circuitry
  - Low Figure-of-Merit (FOM): Ron x Qa
  - Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

## **APPLICATIONS**

- Consumer Electronics
  - Displays (LCD or Plasma TV)
- Lighting
- Industrial
  - Welding - Induction Heating
  - Motor Drives
  - Battery Chargers
- SMPS

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP17N60D-E3
Lead (Pb)-free and Halogen-free	SiHP17N60D-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V <sub>DS</sub>	600	V	
Gate-Source Voltage			V <sub>GS</sub>	± 30	v
Continuous Drain Current (T 150 °C)	V at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I <sub>D</sub>	17	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V T <sub>C</sub>	T <sub>C</sub> = 100 °C		10.7	A
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	48	1	
Linear Derating Factor				2.22	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	165.6	mJ
Maximum Power Dissipation			PD	277.8	W
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt	24	)//aa	
Reverse Diode dV/dt <sup>d</sup>			0.2	V/ns	
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for	10 s		300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 2.3 mH,  $R_a = 25 \Omega$ ,  $I_{AS} = 12$  A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , starting  $T_J = 25$  °C.

S12-0813-Rev. B, 30-Apr-12





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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.45	0/10	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.7	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		3	-	5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA
Zero Gate Voltage Drain Current	l	V <sub>DS</sub> =	= 600 V, V <sub>GS</sub> = 0 V	-	-	1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	100	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 8 A	-	0.275	0.340	Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 8 A	-	6.2	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V,$	-	1780	-	
Output Capacitance	C <sub>oss</sub>		V <sub>DS</sub> = 100 V,	-	140	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MHz	-	15	-	
Total Gate Charge	Qg			-	45	90	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$I_D = 8 \text{ A}, V_{DS} = 480 \text{ V}$	-	14	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	22	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	22	45	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 8 A		-	56	85	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 9$	9.1 Ω, V <sub>GS</sub> = 10 V	-	37	75	ns
Fall Time	t <sub>f</sub>			-	30	60	1
Internal Gate Resistance	Rg	f = 1 MHz, open drain		-	1.6	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET syml showing the		-	-	17	Α
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse		-	-	48	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 8 A, V <sub>GS</sub> = 0 V	-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	_		-	633	950	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>		= 25 °C, I <sub>F</sub> = I <sub>S</sub> , 100 A/us, V <sub>2</sub> = 20 V	-	7	15	μC
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 100 A/µs, V <sub>B</sub> = 20 V		42	A		

Note

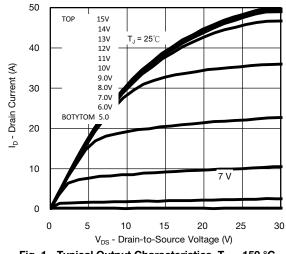
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





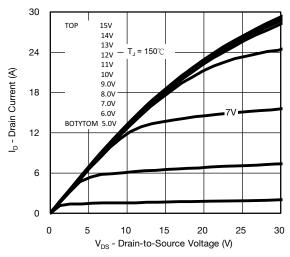
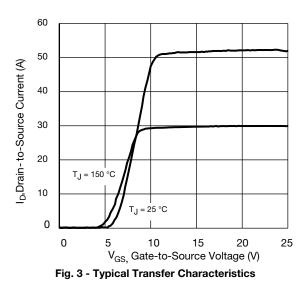


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C



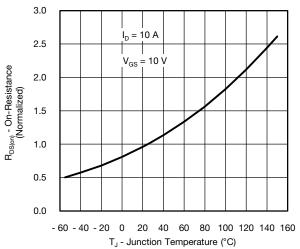


Fig. 4 - Normalized On-Resistance vs. Temperature

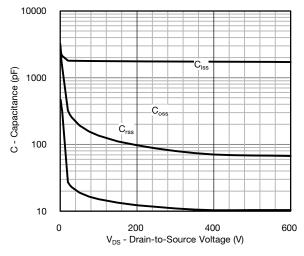


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

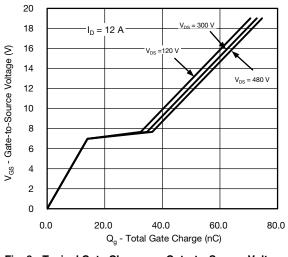


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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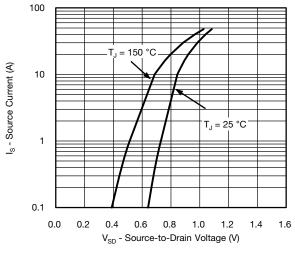
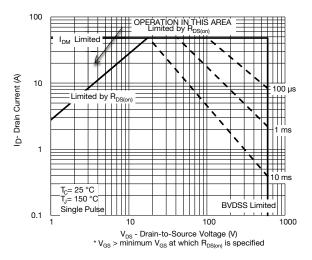
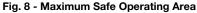


Fig. 7 - Typical Source-Drain Diode Forward Voltage





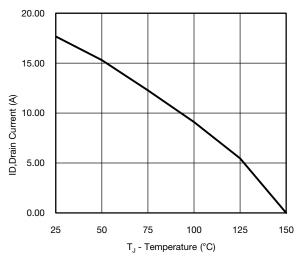


Fig. 9 - Maximum Drain Current vs. Case Temperature

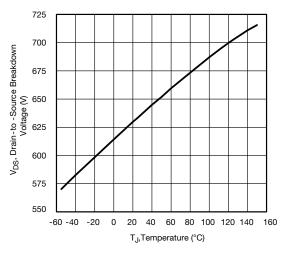
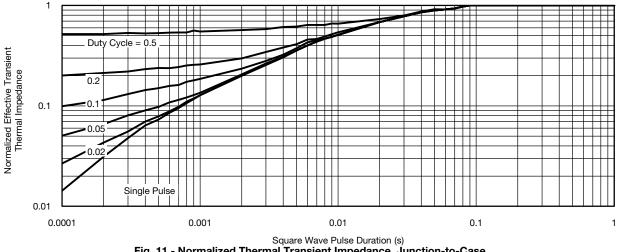
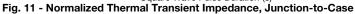


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





S12-0813-Rev. B, 30-Apr-12

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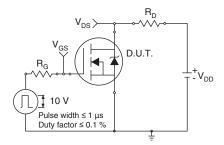


Fig. 12 - Switching Time Test Circuit

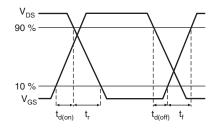


Fig. 13 - Switching Time Waveforms

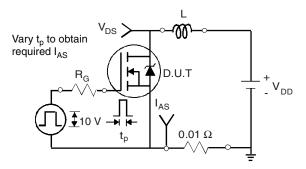


Fig. 14 - Unclamped Inductive Test Circuit

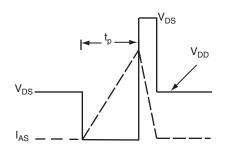


Fig. 15 - Unclamped Inductive Waveforms

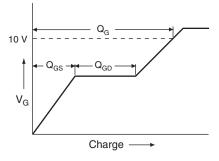


Fig. 16 - Basic Gate Charge Waveform

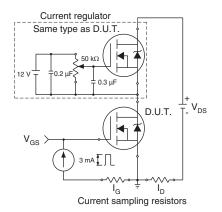
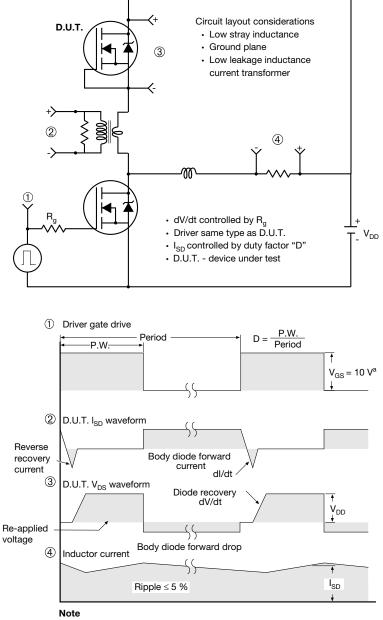


Fig. 17 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 18 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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